TOSHIBA Power MOS FET Module Silicon N Channel MOS Type (L²-π-MOSV 4 in 1)

MP4711

High Power, High Speed Switching Applications
For Printer Head Pin Driver and Pulse Motor Driver
For Solenoid Driver

- 4 V gate drive available
- Package with heat sink isolated to lead (SIP 12 pin)
- High drain power dissipation (4 devices operation)
 PT = 36 W (Tc = 25°C)
- Low drain-source ON resistance: RDS (ON) = 0.17Ω (typ.)
- High forward transfer admittance: $|Y_{fs}| = 4.5 \text{ S (typ.)}$
- Low leakage current: $I_{GSS} = \pm 10 \mu A \text{ (max) (V}_{GS} = \pm 16 \text{ V)}$

 $I_{DSS} = 100 \,\mu A \,(max) \,(V_{DS} = 100 \,V)$

• Enhancement-mode: $V_{th} = 0.8 \text{ to } 2.0 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA})$

Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	100	V	
Drain-gate voltage (R_{GS} = 20 k Ω)		V_{DGR}	100	V	
Gate-source voltage		V _{GSS}	±20	V	
Drain current	DC	I _D	5	А	
Drain current	Pulse	I_{DP}	20	A	
Drain power dissipation (1 device operation, Ta =	: 25°C)	P_{D}	3.0	W	
Drain power dissipation	Ta = 25°C	Рот	5.0		
(4 devices operation)	devices operation) Tc = 25°C		36	W	
Single pulse avalanche e	energy (Note 1)	E _{AS}	180	mJ	
Avalanche current		I _{AR}	5	Α	
Repetitive avalanche energy (Note 2)	1 device operation	E _{AR}	0.3	mJ	
	4 devices operation	E _{ART}	0.5	IIIJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature ran	ge	T _{stg}	−55 to 150	°C	

Note 1: Avalanche energy (single pulse) applied condition

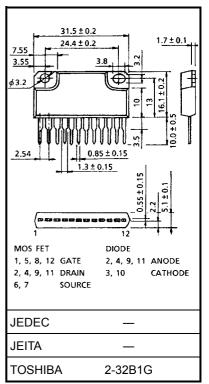
 V_{DD} = 25 V, starting T_{ch} = 25°C, L = 11.6 mH, R_{G} = 25 Ω , I_{AR} = 5 A

Note 2: Repetitive rating; pulse width limited by maximum channel temperature.

This transistor is an electrostatic sensitive device. Please handle with caution.

Industrial Applications

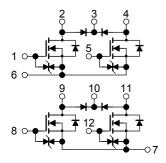
Unit: mm



Weight: 6.0 g (typ.)



Array Configuration



Thermal Characteristics

Characteristics	Symbol	Max	Unit	
Thermal resistance of channel to ambient	ΣR _{th (ch-a)}	25	°C/W	
(4 devices operation, Ta = 25°C)				
Thermal resistance of channel to case	7 D	3.47	°C/W	
(4 devices operation, Tc = 25°C)	ΣR _{th (ch-c)}	3.47		
Maximum lead temperature for soldering purposes	TL	260	°C	
(3.2 mm from case for t = 10 s)				

Electrical Characteristics (Ta = 25°C)

Chara	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage curr	ent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μΑ
Drain cut-off curre	nt	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V	_	_	100	μΑ
Drain-source brea	kdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	100	_	_	V
Gate threshold vo	Itage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	0.8	_	2.0	V
Drain-source ON I	resistance	D	V _{GS} = 4 V, I _D = 2.5 A	1	0.22	0.30	Ω
Drain-source ON resistance	R _{DS (ON)}	V_{GS} = 10 V, I_D = 2.5 A		0.17	0.23	12	
Forward transfer a	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 2.5 A	2.0	4.5	_	S
Input capacitance		C _{iss}	V -10 V V -0 V	_	500	_	pF
Reverse transfer of	capacitance	C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V f = 1 MHz	-	80	_	pF
Output capacitano	e	Coss	1 - 1 WII IZ	_	190	_	pF
Rise time Turn-on time Fall time Turn-off time	t _r	$I_D = 2.5 \text{ A}$ V_{GS} V_{OUT}	_	17	_		
	Turn-on time	t _{on}	0 V	ı	25	ı	ns
	t _f	C	ı	50	ı	115	
	Turn-off time	t _{off}	V_{IN} : t_r , $t_f < 5$ ns, duty $\le 1\%$, $t_W = 10 \ \mu s$	_	195	_	
Total gate charge (gate-source plus	gate-drain)	Qg	V _{DD} ≈ 80 V, V _{GS} = 10 V	-	22	_	nC
Gate-source charge		Q _{gs}	I _D = 5 A	_	15	_	nC
Gate-drain ("miller	") charge	Q_{gd}			7	_	nC

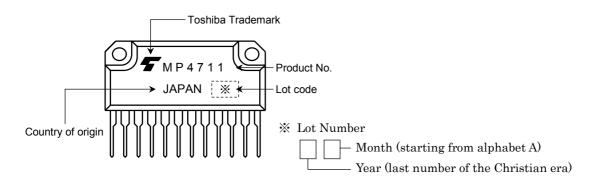
Source-Drain Diode Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current	I _{DR}	_	_	_	5	Α
Pulse drain reverse current	I _{DRP}	_	ı	-	20	Α
Diode forward voltage	V_{DSF}	I _{DR} = 5 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 5 A, V _{GS} = 0 V	_	160	_	ns
Reverse recovery charge	Q _{rr}	dl _{DR} /dt = 50 A/μs	_	0.28	_	μC

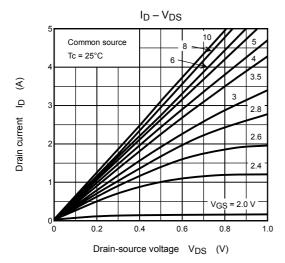
Flyback-Diode Rating and Characteristics (Ta = 25°C)

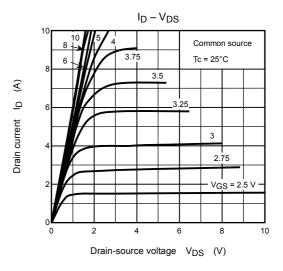
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward current	I _{FM}	_	_	_	5	Α
Reverse current	I _R	V _R = 100 V	_	_	0.4	μA
Reverse voltage	V_{R}	I _R = 100 μA	100	_	_	V
Forward voltage	V _F	I _F = 2 A		_	2.3	V

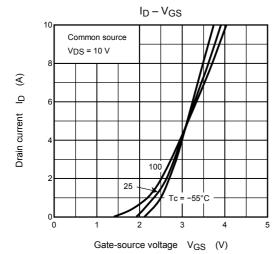
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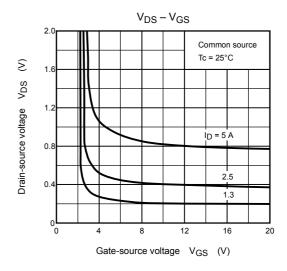


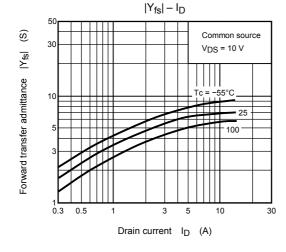
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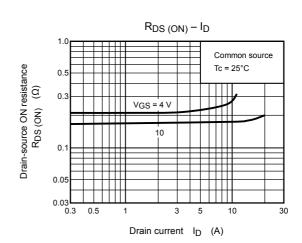


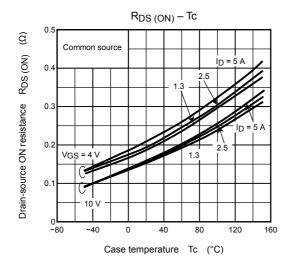


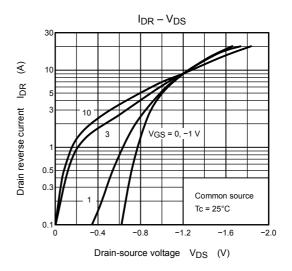


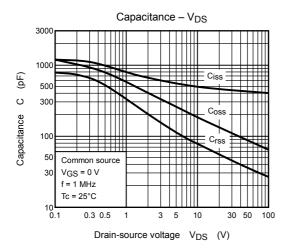


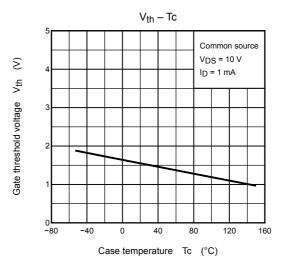


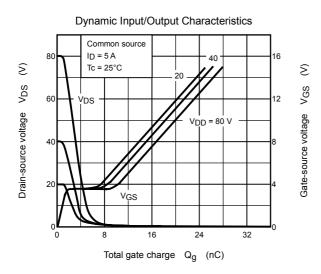


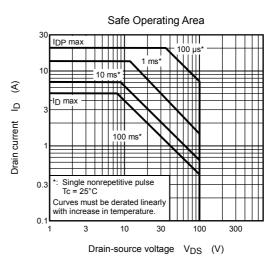


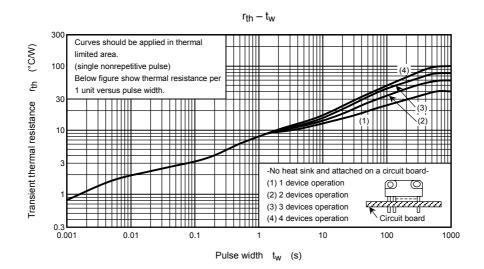


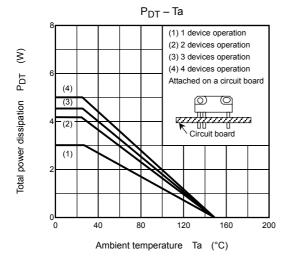


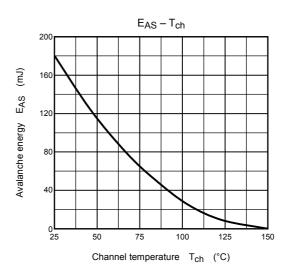


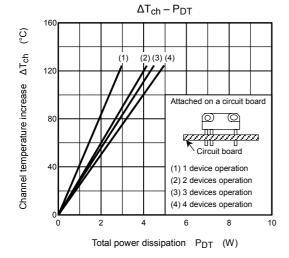


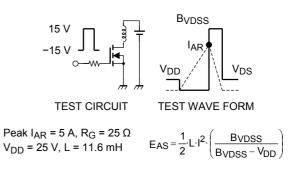












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